

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



### Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

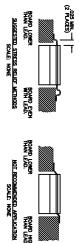
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







### 1. OPERATING TEMPERATURE: -55°C TO +150°C. (SEE CHART) NOTES REV RCN INITIAL RELEASE DESCRIPTION REVISIONS



3. LEAD LENGTH: 150 MIN.

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CHANGE FROM ELECTROLESS TO ELECTROLYTIC

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**UPDATE DRAWING & REVISE SPEC DATA** 

UPDATED FLANGE DIMENSIONS

150-100RL

80925 REFORMAT DWG NO.

2. DESIGNED TO MEET OR EXCEED APPLICABLE PORTIONS OF MIL-E-5400 & MIL-R-55342.

### BOARD HIGHER THAN LEAD.

## SUGGESTED MOUNTING PROCEDURES:

- MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
- DRILL & TAP THE HEATSINK FOR THE APPROPRIATE THREAD SIZE TO BE USED.
- COAT HEATSINK WITH A MINIMUM AMOUNT OF HIGH QUALITY SILICONE GREASE (.001" MAX. THICKNESS).
- POSITION DEVICE ON MOUNTING SURFACE & SECURE USING SOCKET HEAD SCREWS, FLAT & SPUIT WASHER. TORQUE SCREWS TO THE APPROPRIATE VALUE. MAKE SURE THAT THE DEVICE IS FLAT AGAINST THE HEATSINK. (CARE SHOULD BE TAKEN TO AVOID UPWARD PRESSURE OF THE LEADS TOWARDS THE LID).
- SOLDER LEADS IN PLACE USING 60/40 TYPE SOLDER WITH A CONTROLLED TEMPERATURE IRON (210°C).
- \*\* FOR MORE DETAILS CONTACT FACTORY \*\*

## GENERAL SPECIFICATIONS:

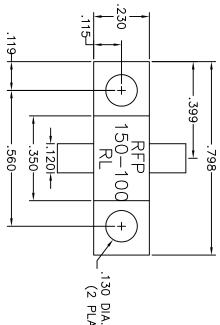
SUBSTRATE: RESISTIVE ELEMENT: COVER: BERYLLIUM OXIDE CERAMIC PROPRIETARY THICK FILM

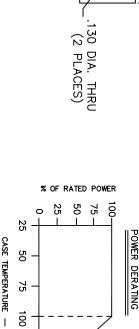
MOUNTING FLANGE: ALUMINA CERAMIC

LEAD(S): 99.99% PURE SILVER (.005" THK.) COPPER, ELECTROLYTIC NICKEL PER QQ-N-290

# PERFORMANCE SPECIFICATIONS:

RESISTANCE VALUE: FREQUENCY RANGE: CAPACITANCE: INPUT POWER: DC - 2.0 GHz. 2.9 pF TYPICAL 100 OHMS, ±5% 150 WATTS



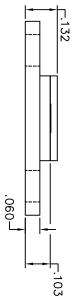


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